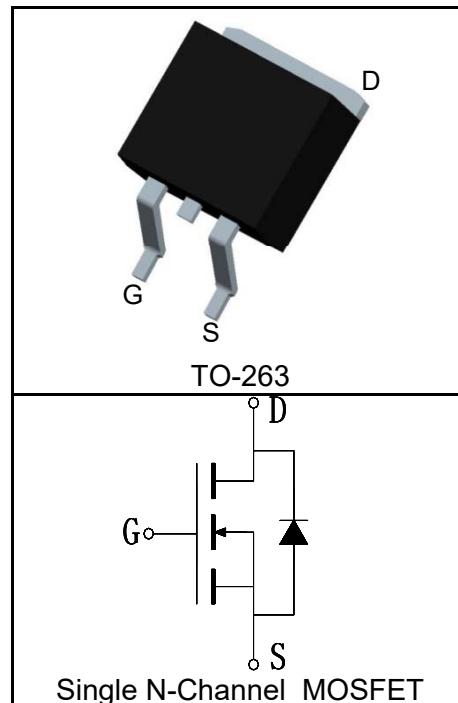


Features

- 40V/300A, $R_{DS\ (ON)} = 1.6\text{m}\Omega$ (Typ.)@ $V_{GS}=10\text{V}$
- Low $R_{DS\ (ON)}$
- Super High Dense Cell Design
- Fast Recovery Body Diode
- 100% Avalanche Tested

Pin Description



Applications

- Synchronous Rectification
- UPS Inverter
- High efficiency DC/DC Converters



Halogen-Free

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
Common Ratings ($T_C=25^\circ\text{C}$ Unless Otherwise Noted)			
V_{DSS}	Drain-Source Voltage	40	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	175	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
I_S	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$	A
Mounted on Large Heat Sink			
$I_{DP}^{(1)}$	300 μs Pulse Drain Current Tested	$T_C=25^\circ\text{C}$	1200
$I_D^{(2)}$	Continuous Drain Current($V_{GS}=10\text{V}$)	$T_C=25^\circ\text{C}$	300
		$T_C=100^\circ\text{C}$	211
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	300
		$T_C=100^\circ\text{C}$	150
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.5	$^\circ\text{C}/\text{W}$
$R_{\theta JA}^{(3)}$	Thermal Resistance-Junction to Ambient	62.5	$^\circ\text{C}/\text{W}$
Drain-Source Avalanche Ratings			
$E_{AS}^{(4)}$	Avalanche Energy, Single Pulsed	722	mJ

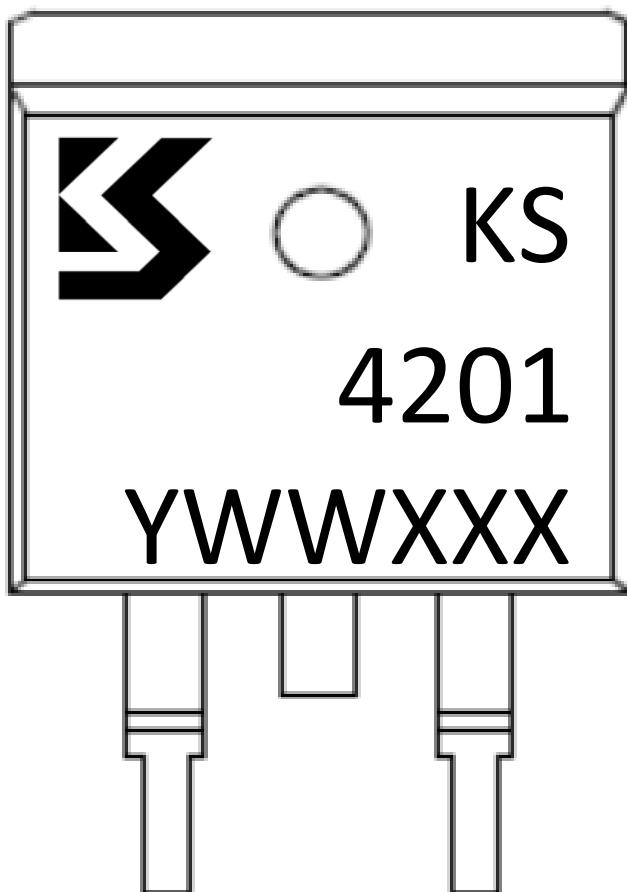
Electrical Characteristics (T_C=25°C Unless Otherwise Noted)

Symbol	Parameter	Test Condition	KS4201GA			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	40			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =40V, V _{GS} =0V			5	μA
		T _J =125°C			100	
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250μA	2		4	V
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
R _{DS(ON)} ^⑤	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =80A		1.6	2	mΩ
Diode Characteristics						
V _{SD} ^⑤	Diode Forward Voltage	I _{SD} =80A, V _{GS} =0V		0.9	1.2	V
t _{rr}	Reverse Recovery Time	I _{SD} =100A, dI _{SD} /dt=100A/μs		55		ns
Q _{rr}	Reverse Recovery Charge			43		nC
Dynamic Characteristics^⑥						
R _G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz		3.6		Ω
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =20V, Frequency=1.0MHz		12800		pF
C _{oss}	Output Capacitance			1100		
C _{rss}	Reverse Transfer Capacitance			370		
t _{d(ON)}	Turn-on Delay Time	V _{DD} =20V, I _{DS} =50A, V _{GEN} =10V, R _G =10Ω		27		ns
t _r	Turn-on Rise Time			85		
t _{d(OFF)}	Turn-off Delay Time			203		
t _f	Turn-off Fall Time			96		
Gate Charge Characteristics^⑥						
Q _g	Total Gate Charge	V _{DS} =20V, V _{GS} =10V, I _{DS} =100A		129		nC
Q _{gs}	Gate-Source Charge			33		
Q _{gd}	Gate-Drain Charge			24		

- Notes:
- ①Pulse width limited by safe operating area.
 - ②Calculated continuous current based on maximum allowable junction temperature. The package limitation current is 75A.
 - ③When mounted on 1 inch square copper board, t≤10sec. The value in any given application depends on the user's specific board design.
 - ④Limited by T_{Jmax}, I_{AS} =53A, L=0.5mH, V_{DD} = 24V, R_G = 25Ω , Starting TJ = 25°C.
 - ⑤Pulse test; Pulse width≤300μs, duty cycle≤2%.
 - ⑥Guaranteed by design, not subject to production testing.

Ordering and Marking Information

Device	Package	Packaging	Quantity	Reel Size	Tape width
KS4201GA	TO-263	Tape&Reel	800	13"	24mm

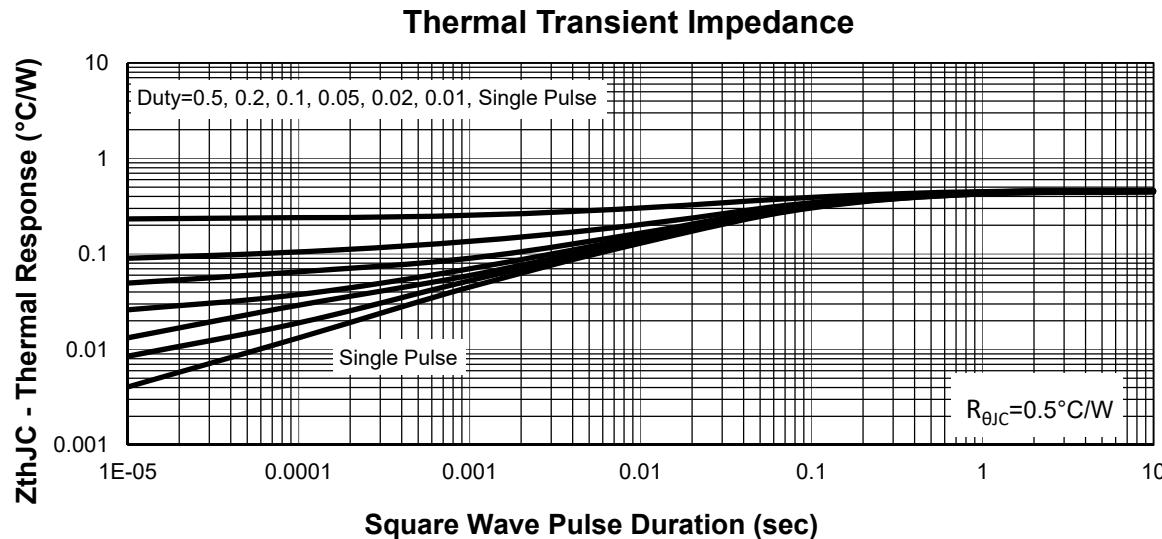
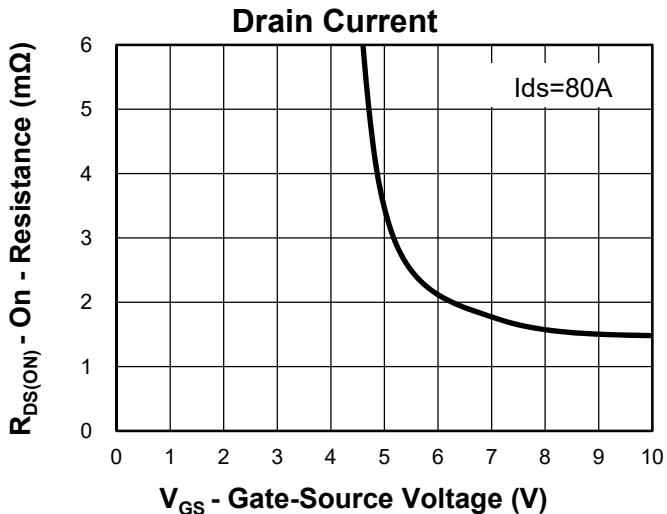
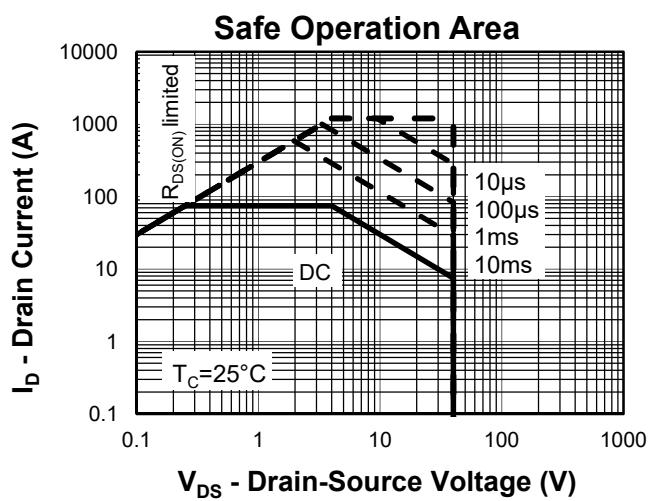
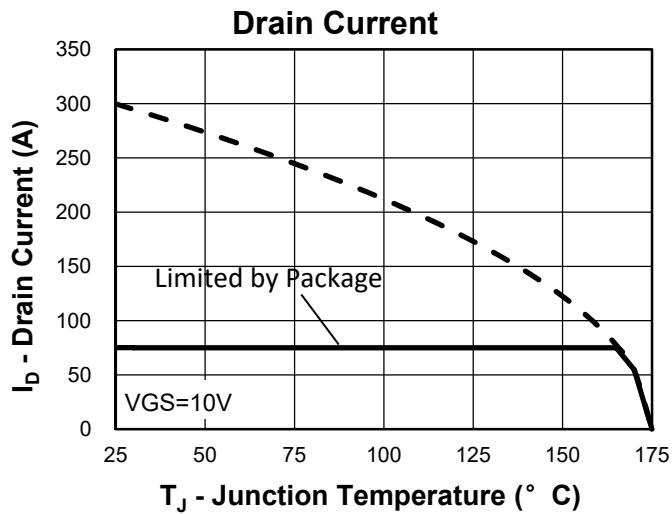
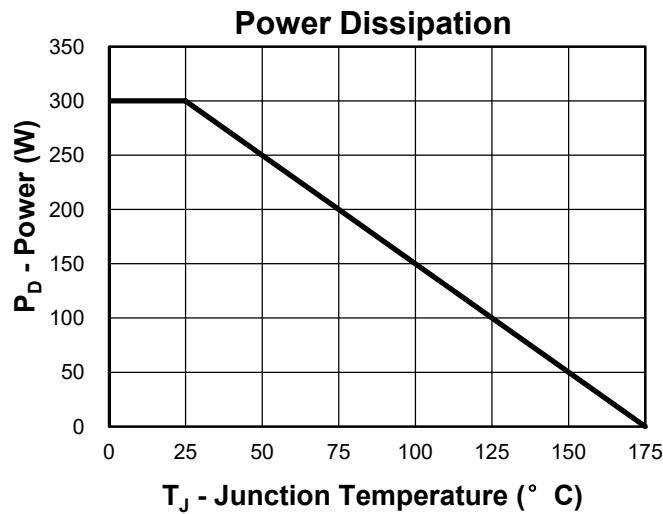


Y =Year,2017-A,2018-B,etc.

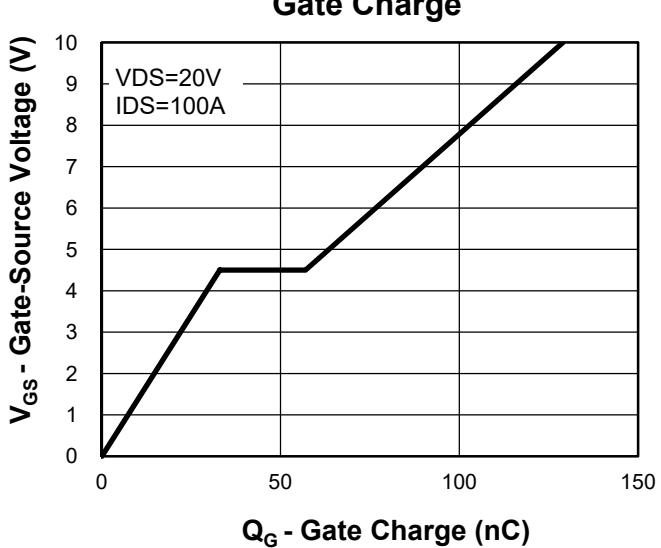
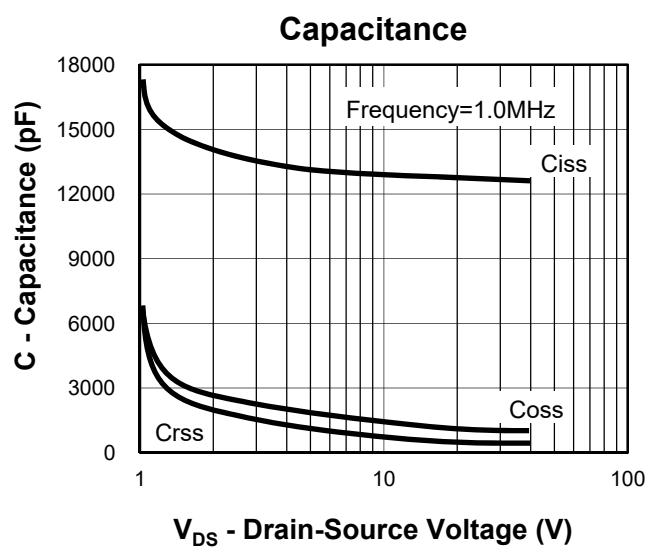
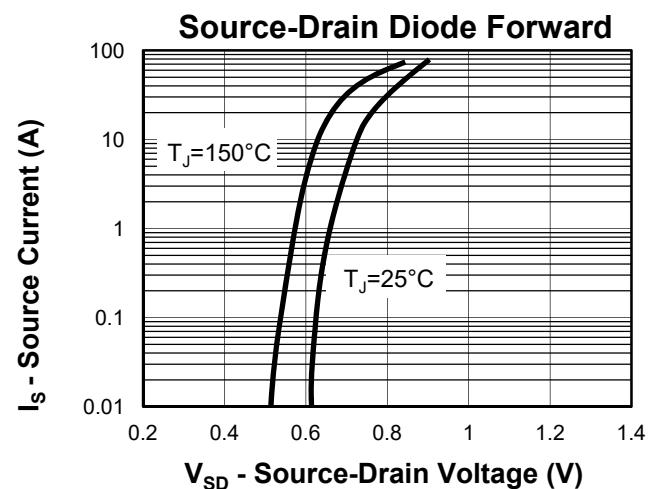
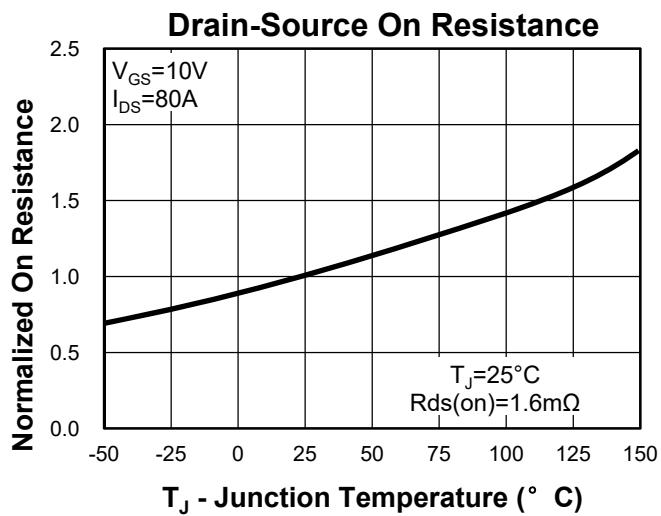
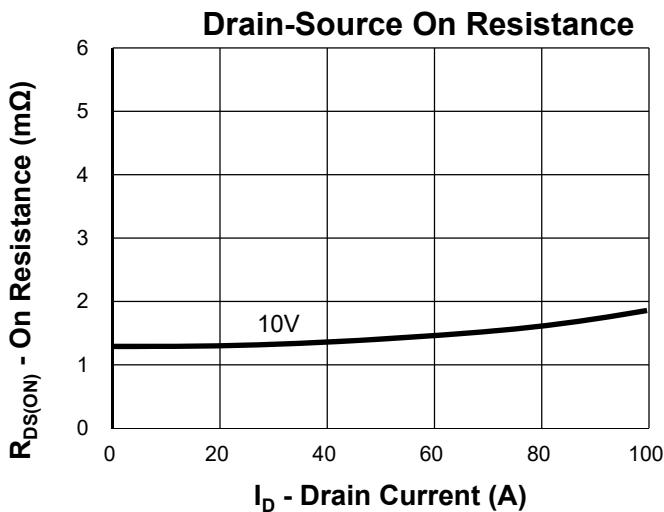
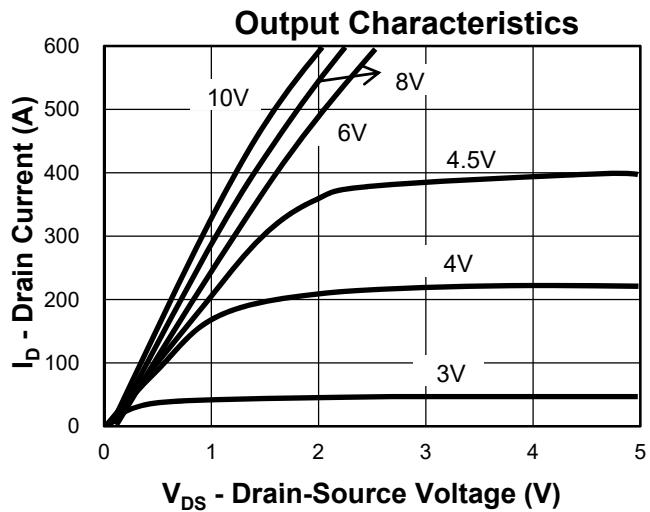
WW =Week.

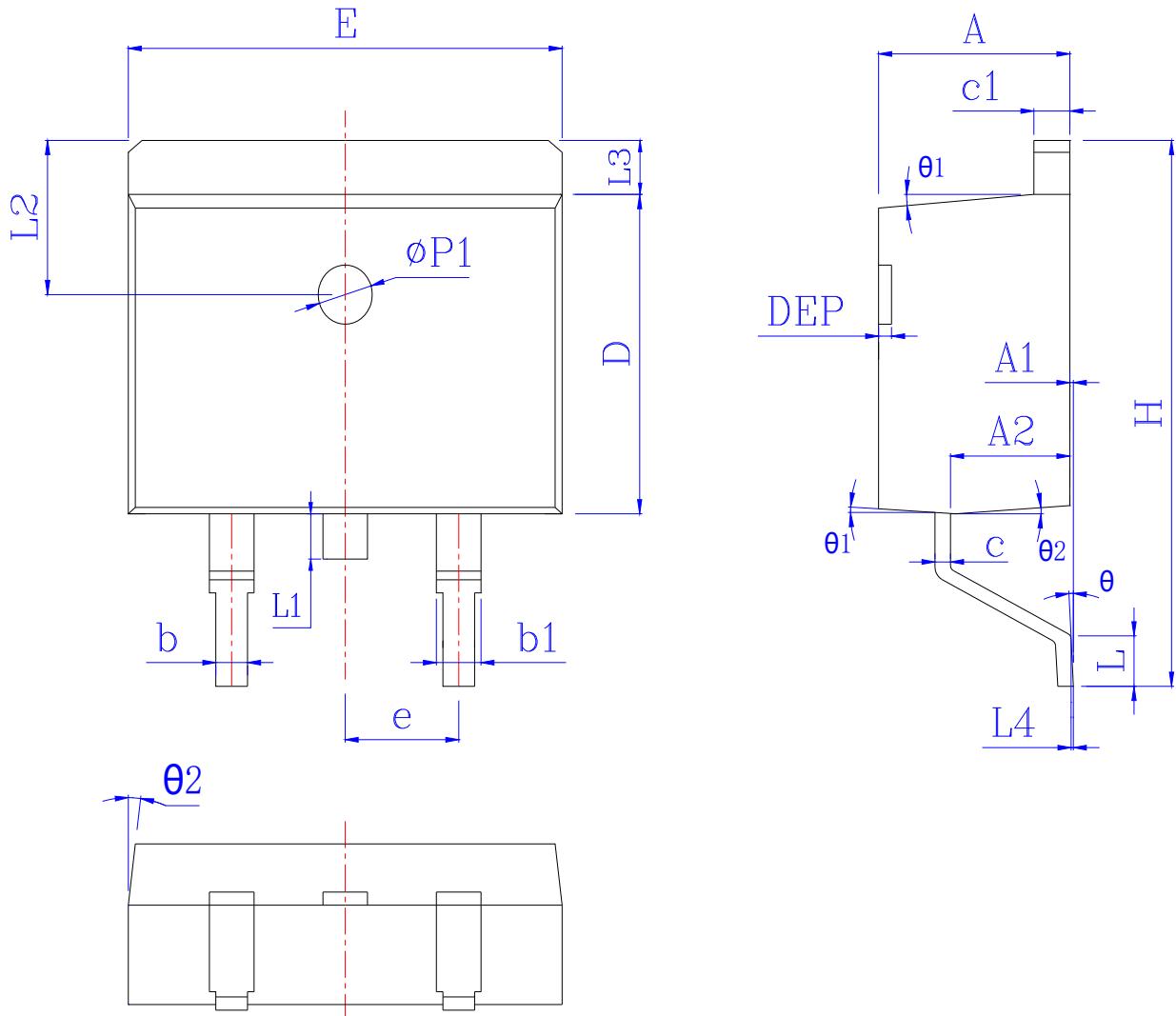
XXX =Lot number.

Typical Characteristics



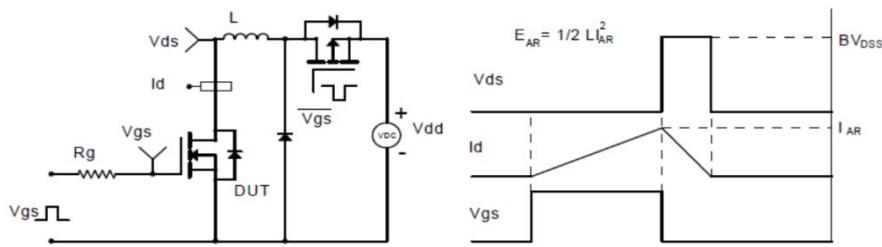
Typical Characteristics



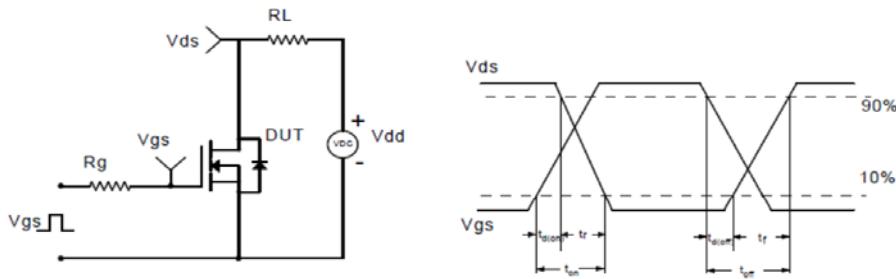
Package Information
TO-263


SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	4.40	4.55	4.72	0.173	0.179	0.186	L	1.94	2.30	2.60	0.076	0.091	0.102
A1	0.00	0.10	0.25	0.000	0.005	0.010	L3	1.17	1.29	1.40	0.046	0.051	0.055
A2	2.59	2.69	2.79	0.102	0.106	0.110	L1	*	*	1.70	*	*	0.067
b	0.76	*	0.90	0.030	*	0.035	L4	0.25 BSC			0.01 BSC		
b1	1.22	*	1.36	0.048	*	0.054	L2	2.50 REF			0.098 REF		
c	0.33	*	0.47	0.013	*	0.019	theta	0°	*	8°	0°	*	8°
c1	1.22	*	1.32	0.048	*	0.052	theta1	5°	7°	9°	5°	7°	9°
D	8.60	*	9.29	0.339	*	0.366	theta2	1°	3°	5°	1°	3°	5°
E	9.95	*	10.26	0.392	*	0.404	DEP	0.05	0.10	0.20	0.002	0.004	0.008
e	2.54BSC			0.100BSC			Phi1	1.40	1.50	1.60	0.055	0.059	0.063
H	14.70	15.10	15.79	0.579	0.594	0.622							

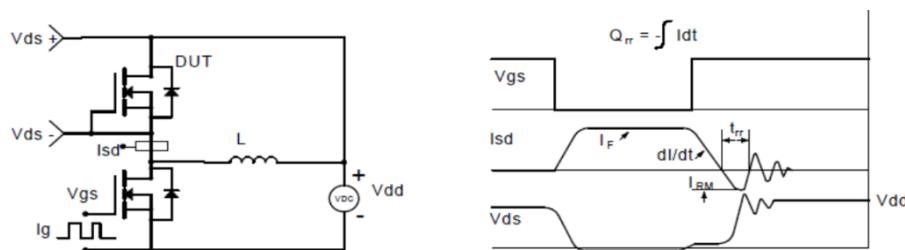
Avalanche Test Circuit and Waveforms



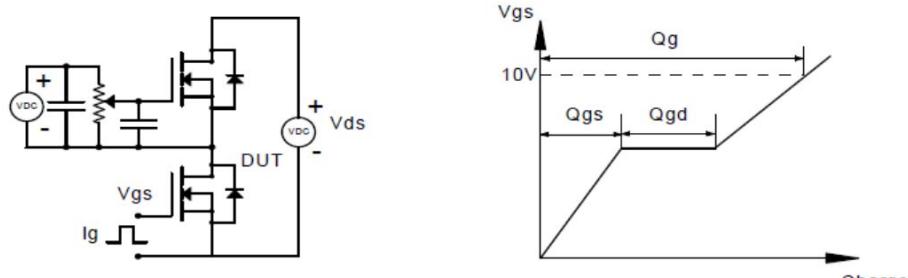
Switching Time Test Circuit and Waveforms



Diode Recovery Test Circuit and Waveforms



Gate Charge Test Circuit and Waveform



Customer Service

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